04-21-2004 FORM PTO-1595 (Modified) RECOI U.S. DEPARTMENT OF COMMERCE (Rev. 03-01) Patent and Trademark Office 4.14.04 OMB No. 0651-0027 (exp.5/31/2002) P08A/REV03 Tab settings → → 102726763 To the Director of the United States Patent and Trademark Office: Please record the attached original documents or copy thereof. 1. Name of conveying party(ies): 2. Name and address of receiving party(ies): Hirotsugu KOJIMA Teruo KITAMURA Name: Renesas Technology Corp. Address: 4-1, Marunouchi 2-chome Chiyoda-ku Additional names(s) of conveying party(ies) Yes No 3. Nature of conveyance: ☑ Assignment ☐ Merger City: Tokyo ☐ Security Agreement Change of Name State/Prov.: Country: Japan Other ZIP: Execution Date: 2/27/04 and 3/10/04 Additional name(s) & address(es) □ Yes ☑ No 4. Application number(s) or patent numbers(s): If this document is being filed together with a new application, the execution date of the application is: 2/27/04 & 3/10/04 Patent Application No. Filing date B. Patent No.(s) 04/15/2004 EFLORES 00000024 10823581 D2 FC:8021 40.00 0 ☐ Yes ☒ No Additional numbers Name and address of party to whom correspondence 6. Total number of applications and patents involved: concerning document should be mailed: Name: Mitchell W. Shapiro 7. Total fee (37 CFR 3.41):....\$ 40.00 31,568 Registration No. Enclosed - Any excess or insufficiency should be credited or debited to deposit account Address: Miles & Stockbridge P.C. Authorized to be charged to deposit account 1751 Pinnacle Drive 8. Deposit account number: Suite 500 City: McLean State/Prov.: VA 50-1165 Country: United States ZIP: 22102 (Attach duplicate copy of this page if paying by deposit account) DO NOT USE THIS SPACE Statement and signature. To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document. Mitchell W. Shapiro April 14, 2004 Name of Person Signing Date Total number of pages including cover sheet, attachments, and

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## **ASSIGNMENT**

(譲渡証)

As a below named inventor, I hereby declare that:

IN CONSIDERATION of the sum of One Dollar (\$1.00) or the equivalent thereof, and other good and valuable consideration paid to me citizen of Japan by Renesas Technology Corp., a corporation organized under the laws of Japan,

located at 4-1, Marunouchi 2-chome, Chiyoda-ku, Tokyo, Japan,

receipt of which is hereby acknowledged I do hereby sell and assign to said Renesas Technology Corp., its successors and assigns, all my right, title and interest, in and for the United States of America, in and to

## SEMICONDUCTOR INTEGRATED CIRCUIT AND ELECTRONIC SYSTEM

invented by me (if only one is named below) or us (if plural inventors are named below) and described in the application for United States Letters Patent therefor, executed on even date herewith, and all United States Letters Patent which may be granted therefor, and all divisions, continuations and extensions thereof, the said interest being the entire ownership of the said Letters Patent when granted,

to be held and enjoyed by said Renesas Technology Corp.,

its successors, assigns or other legal representatives, to the full end of term for which said Letters Patent may be granted as fully and entirely as the same would have been held and enjoyed by me or us if this assignment and sale had not been made;

And I hereby agree to sign and execute any further documents or instruments which may be necessary, lawful, and proper in the prosecution of the above-named application or in the preparation and prosecution of any continuing, continuation-in-part, substitute, divisional, renewal, reviewed or reissue applications or in any amendment, extension, or interference proceedings, or otherwise to secure the title thereto in said assignee;

And I do hereby authorize and request the Commissioner of Patents to issue said Letters Patent to said Renesas Technology Corp.,

Signed on the date(s) indicated aside our signatures:

RECORDED: 04/14/2004

INVENTOR(S) (発明者フルネームサイン)	Date Signed (署名日)
1) And Hirotsugu KOJIMA	Feb., 27, 2004
2) Teruo KITAMURA Teruo KITAMURA	10/March/2004
3)	
4)	
5)	
6)	
7)	
8)	
9)	
10)	

PATENT REEL: 015224 FRAME: 0392